

FTP08N06NE

N-Channel MOSFET

Applications:

- Adaptor
- Charger
- .SMPS

Features:

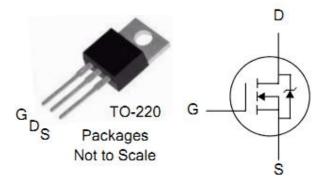
- RoHS Compliant
- Low ON Resistance
- Low Gate Charge
- Peak Current vs Pulse Width Curve
- Inductive Switching Curves

Ordering Information

PART NUMBER	PACKAGE	BRAND	
FTP08N06NE	TO-220	IPS	



V_{DSS}	R _{DS(ON)} (Typ.)	ID (Silicon
60V	$6.5 m\Omega$	100A



Absolute Maximum Ratings $T_C=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	FTP08N06NE	Units
V _{DSS}	Drain-to-Source Voltage	60	V
I _D	Continuous Drain Current	100	А
	Continuous Drain Current T _C =100 °C	60	А
I _{DM}	Pulsed Drain Current (NOTE *1)	400	Α
V _{GS}	Gate-to-Source Voltage	±20	V
E _{AS}	Single Pulse Avalanche Energy(NOTE *2)	347	mJ
T _L	Maximum Temperature for Soldering	300	
T _J and T _{STG}	Operating Junction and Storage Temperature Range	150,-55 to150	${\mathbb C}$

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OFF Characteristics $T_C=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	60			V	V _{GS} =0V, I _D =250μA
	Drain-to-Source Leakage Current			1	μA	V_{DS} =60V, V_{GS} =0V
						T _J =25℃
IDSS				500		V_{DS} =48V, V_{GS} =0V
				500		T _J =125℃
1	Gate-to-Source Forward Leakage Gate-to-Source Reverse Leakage			+100	n 1	V _{GS} =+20V
I _{GSS}				-100	nA	V _{GS} = -20V

ON Characteristics T_J=25 °C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
R _{DS(ON)}	StaticDrain-to-Source On-Resistance		6.5	8.5	mΩ	V_{GS} =10V, I_D =40A
V _{GS(TH)}	Gate Threshold Voltage	2	3	4	V	$V_{DS}=V_{GS},I_{D}=250\mu A$
Pulse width	≤300µs; duty cycle≤ 2%					

Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Rg	Gate Resistance		1.7		Ω	$f=1MHz$, $V_{GS}=0V$, $V_{DS}=0V$
C _{iss}	Input Capacitance		3348			V DS=O V
Coss	Output Capacitance		349		pF	V_{GS} = 0V, V_{DS} = 25V f =1.0MHz
C _{rss}	Reverse Transfer Capacitance		300		ρı	
Q _g	Total Gate Charge		73			I_{D} =50A, V_{DD} =48V V_{GS} = 10V
Q_{gs}	Gate-to-Source Charge		16		nC	
Q_{gd}	Gate-to-Drain ("Miller") Charge		30			

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
t _{d(ON)}	Turn-on Delay Time		25.4		- ns	V_{DD} =30V, I_{D} =50A, V_{G} =10V R_{G} =6 Ω
t _{rise}	Rise Time		18			
t _{d(OFF)}	Turn-Off Delay Time		60			
t _{fall}	Fall Time		22]	



Source-Drain Diode Characteristics Tc=25 ℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
	Continuous Source Current			100	А	T _C =25℃
Is	(Body Diode)					
	Maximum Pulsed Current			400	А	
I _{SM}	(Body Diode)					
V_{SD}	Diode Forward Voltage			1.2	V	I_{SD} =30A, V_{GS} =0V
t _{rr}	Reverse Recovery Time		36		ns	I _F =20A
Q _{rr}	Reverse Recovery Charge		55		nC	di/dt=100A/us
Pulse width ≤300µs; duty cycle ≤ 2%						

Notes:

^{*1.} Repetitive rating; pulse width limited by maximum junction temperature.

^{*2.} L=0.5mH, I_D =37A, Start T_J =25 $^{\circ}$ C



Test Circuits and Waveforms

Figure 14. Gate Charge Test Circuit

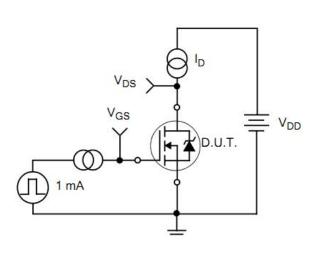


Figure 15. Gate Charge Waveforms

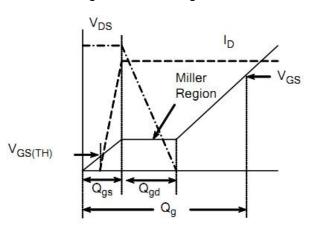
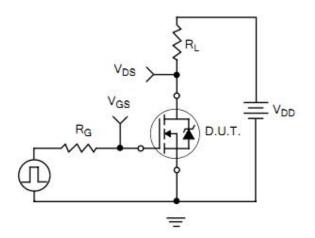


Figure 16. Resistive Switching Test Circuit

Figure 17. Resistive Switching Waveforms



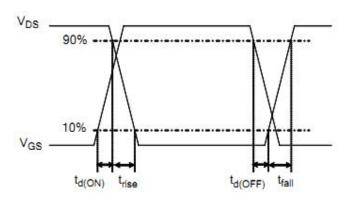




Figure 18. Diode Reverse Recovery Test Circuit

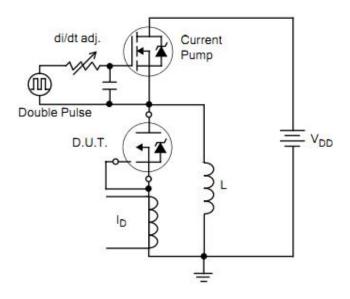


Figure 19. Diode Reverse Recovery Waveform

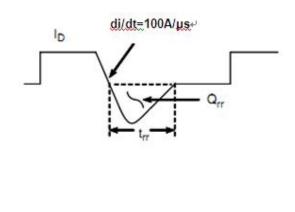
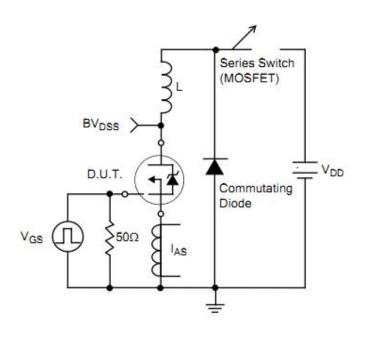
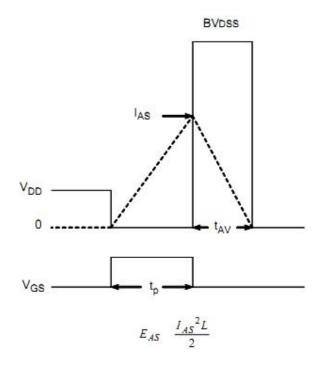


Figure 20. Unclamped Inductive Switching Test Circuit

Figure21.Unclamped Inductive Switching Waveform





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